

# PHOTONICS+

## Virtual Exhibition and Conference

### PHOTONICS+ EPIC Virtual Exhibition and Conference

- 300 exhibitors and company presentations
- 10.000 participants
- 30 keynote speakers primarily users of photonics sharing their use of photonics and challenges. Presentations are 15 minutes video call followed by 5 minutes interactive Q&A moderated by Dr. Jose Pozo, CEO, EPIC. See EPIC's unique online meeting style on <https://www.youtube.com/c/EPICPhotonics>

### KEYNOTE SPEAKERS PROGRAM

<p><b>Wednesday 17 February 2021</b></p> <p><b>13:00 CEST Session on Imaging</b></p> <ul style="list-style-type: none"><li>• Medical: <b>Philips</b></li><li>• Machine Vision: <b>ABB</b></li><li>• Defense: <b>MBDA</b></li></ul> <p><b>14:00 CEST Session on Fiber Sensors</b></p> <ul style="list-style-type: none"><li>• Energy: <b>TOTAL</b></li><li>• Aeronautics: <b>Airbus</b></li><li>• Automotive: <b>Audi</b></li></ul> <p><b>15:00 CEST Session on Photonics in Semiconductor Manufacturing</b></p> <ul style="list-style-type: none"><li>• Lithography: <b>ASML</b></li><li>• Semiconductor Manufacturer: <b>ST Microelectronics</b></li><li>• Consumer Electronics: <b>Electrolux</b></li></ul> <p><b>16:00 CEST Session on MicroLED and Micro Optics</b></p> <ul style="list-style-type: none"><li>• Lighting: <b>OSRAM Continental</b></li><li>• Automotive: <b>VOLVO</b></li><li>• AR/VR: <b>Facebook</b></li></ul> <p><b>17:00 CEST Session on Beyond 400G</b></p> <ul style="list-style-type: none"><li>• Datacenter: <b>CISCO</b></li><li>• Fiber To The Home: <b>Vodafone</b></li><li>• Service Provider: <b>Juan Pedro Fernández Palacios, Head of Unit, Telefónica (SPAIN)</b></li></ul>	<p><b>Thursday 18 February 2021</b></p> <p><b>13:00 CEST Session on Spectroscopy</b></p> <ul style="list-style-type: none"><li>• Food and Beverage: <b>Nestle</b></li><li>• Food Packaging: <b>Tetrapack</b></li><li>• Chemical Process: <b>BASF</b></li></ul> <p><b>14:00 CEST Session on Laser Based Material Processing</b></p> <ul style="list-style-type: none"><li>• Solar: <b>Q-Cells</b></li><li>• Automotive: <b>Daimler</b></li><li>• Metal Processing: <b>Arcelor Mittal</b></li></ul> <p><b>15:00 CEST Session on 3D Sensing/LIDAR</b></p> <ul style="list-style-type: none"><li>• Consumer Electronics: <b>SONY</b></li><li>• Automotive: <b>Joachim Mathes, CTO, Comfort and Driving Assistance, VALEO (FRANCE)</b></li><li>• Defense: <b>BAE</b></li></ul> <p><b>16:00 CEST Session on Freeform Optics</b></p> <ul style="list-style-type: none"><li>• Space: <b>Thales Alenia Space</b></li><li>• AR/VR: <b>Microsoft HoloLens</b></li><li>• Medical: <b>Storz</b></li></ul> <p><b>17:00 CEST Session on Photonics Integrated Circuit</b></p> <ul style="list-style-type: none"><li>• Multicore Processing: <b>Intel</b></li><li>• Co-packaged Optics: <b>Ciena</b></li></ul>
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- Foundry: Anthony Yu, Vice President, Computing and Wired Infrastructure Business Unit, **GLOBALFOUNDRIES (USA)**